

■ 適用模組料號: 1A2I0-I9SP-22R1BS

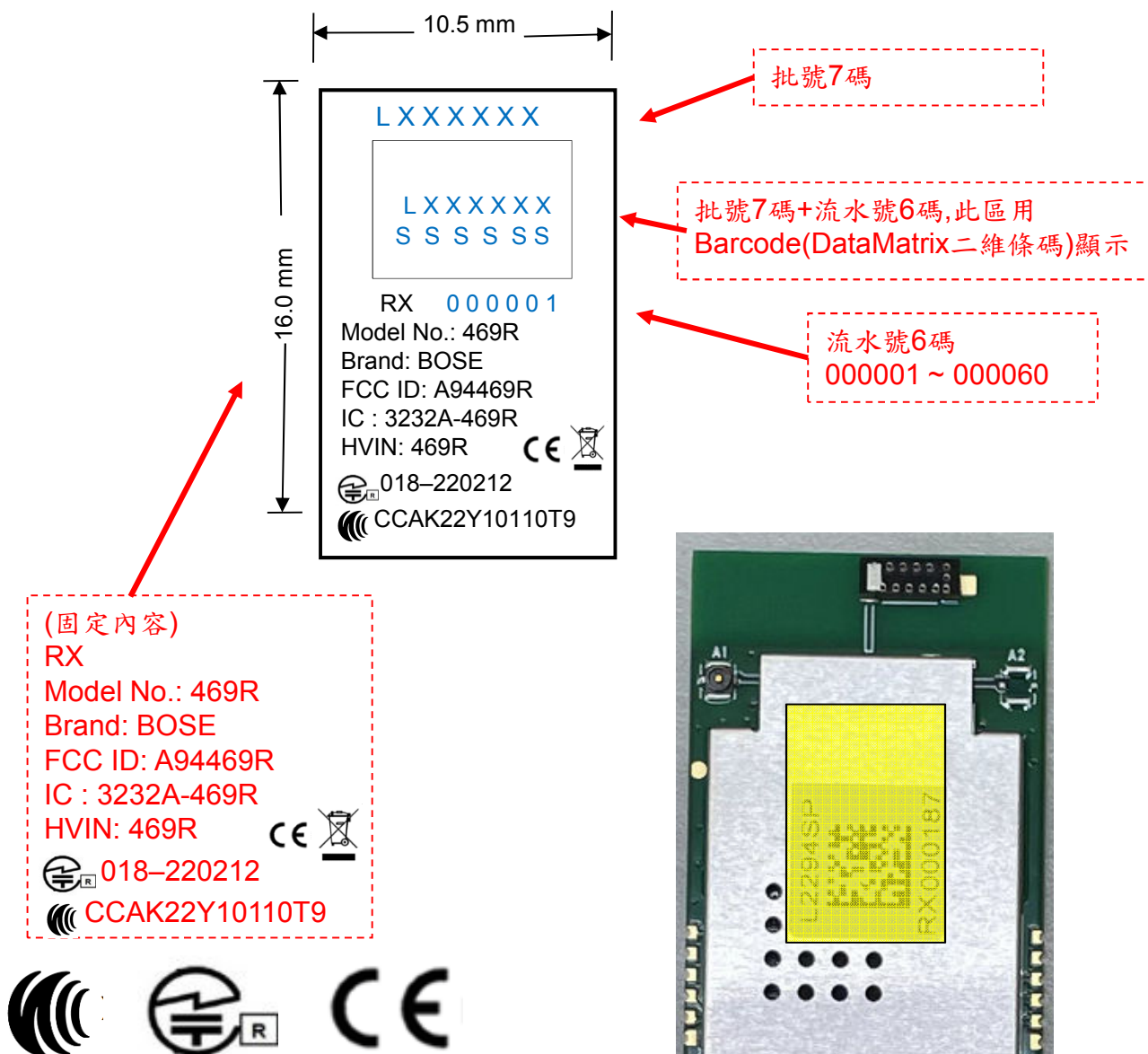
Issue date: 2023/3/17

IA9SP4 Microphone Module_Chip Ant_SMS RX

■ Labe Paper Spec.: High Temp Label 300°C 80sec B478224-1

■ TX Label Size & 印製內容說明
(共壹張Label, Size 10.5mm x 16.0mm)

■ Label location 如下圖黃色範圍所示



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